

10/537529

JC06 Rec'd PCT/PTO 03 JUN 2005

DOCKET NO.: 4887/PCT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN THE MATTER OF THE NEW PCT NATIONAL PHASE PATENT APPLICATION

OF: Makoto OTSUKI et al.

USSN: NEW - TO BE ASSIGNED

FILED: June 3, 2005

USPS EXPRESS MAIL
EV 511 024 369 US
JUNE 03 2005

FOR: Method of Manufacturing Single-Crystal
Semiconductor Wafers and Laser
Machining Apparatus Therefor

INTERNATIONAL SERIAL NO.: PCT/JP2004/008108

INTERNATIONAL FILING DATE: 10 June 2004

MS PCT
COMMISSIONER FOR PATENTS
P.O. BOX 1450
ALEXANDRIA, VA 22313-1450

June 3, 2005

PRELIMINARY AMENDMENT

Dear Sir:

Please amend the above identified patent application as follows.

[AMENDMENT FOLLOWS ON NEXT PAGE]